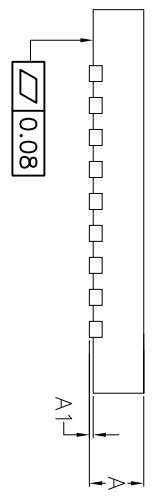
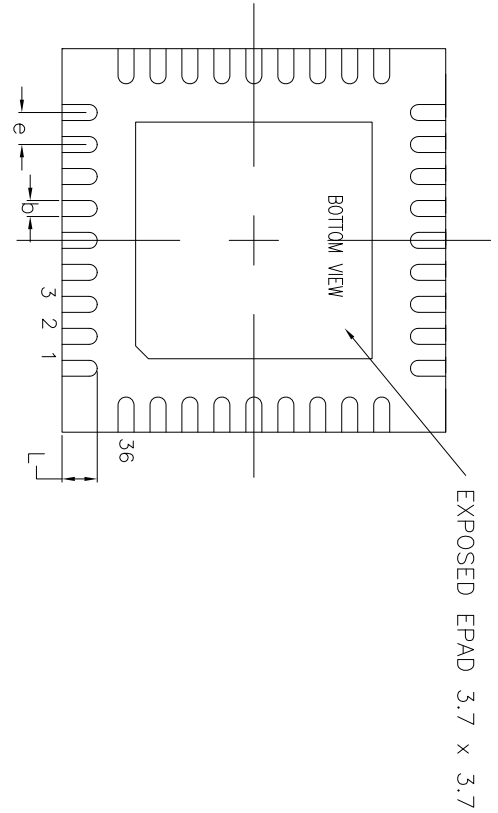
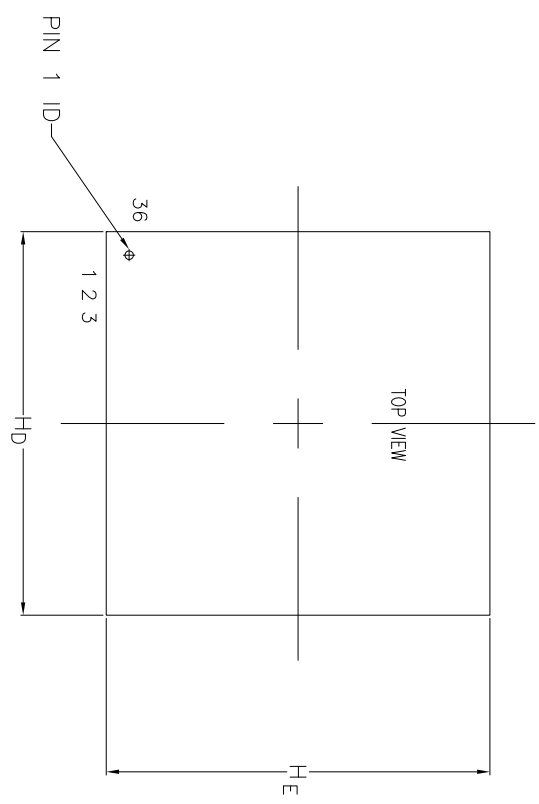


| REVISIONS | | | |
|-----------|-----------------|---------|----------|
| REV | DESCRIPTION | DATE | APPROVED |
| 00 | INITIAL RELEASE | 2/23/16 | JHUJA |

BASED ON JEDEC MO-220
 1. DIMENSIONS (IN MILLIMETERS)



- WEIGHT <math>< 0.1\text{ g}</math>
- PACKAGE BODY MATERIAL LOW STRESS EPOXY
- LEAD MATERIAL Cu-ALLOY
- LEAD FINISH SOLDER PLATING

| DIMENSIONS | min | max |
|------------|------|------|
| A | 0.8 | 0.9 |
| A1 | 0 | 0.05 |
| b | 0.2 | 0.3 |
| e | 0.5 | nom |
| Hd | 5.9 | 6.1 |
| HE | 5.9 | 6.1 |
| L | 0.45 | 0.65 |

| | | | |
|---|----------|--|--------------|
| TOLERANCES UNLESS SPECIFIED | | DATE | |
| DECIMAL | ANGULAR | 12/23/16 | |
| XXX± | ± | | |
| XXXX | | | |
| XXXXX | | | |
| IDT ™ 6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674 | | TITLE NLG36 PACKAGE OUTLINE 6.0 x 6.0 mm BODY , EPAD 3.7 x 3.7 0.50 mm PITCH QFN | |
| APPROVALS | DATE | SIZE | DRAWING No. |
| DRAWN: DAC | 12/23/16 | C | PSC-4648-01 |
| CHECKED | | | |
| DO NOT SCALE DRAWING | | | REV 00 |
| | | | SHEET 1 OF 1 |